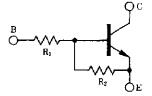


COMPOUND TRANSISTOR

on-chip resistor NPN silicon epitaxial transistor For mid-speed switching

FEATURES

- Current drive available up to 0.7 A
- On-chip bias resistor
- Low power consumption during drive



AB1 SERIES LISTS

Products	R1 (KΩ)	R₂ (KΩ)
AB1A4A	_	10
AB1L2Q	0.47	4.7
AB1A3M	1.0	1.0
AB1F3P	2.2	10
AB1J3P	3.3	10
AB1L3N	4.7	10
AB1A4M	10	10

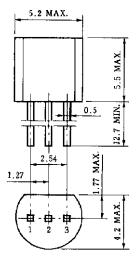
ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	30	V
Collector to emitter voltage	VCEO	25	V
Emitter to base voltage	Vebo	10	V
Collector current (DC)	IC(DC)	0.7	А
Collector current (Pulse)	IC(pulse) *	1.0	А
Base current (DC)	B(DC)	0.02	А
Total power dissipation	Рт	750	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

* PW \leq 10 ms, duty cycle \leq 50 %

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PACKAGE DRAWING (UNIT: mm)



Electrode Connection 1. Emitter ElAJ : SC-43B

2. Collector JEDEC : TO-92

3. Base IEC : PA33

AB1A4A ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = 30 \text{ V}, \text{ I}_{E} = 0$			100	nA
DC current gain	hfe1 **	Vce = 2.0 V, Ic = 0.1 A	300			-
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300			-
DC current gain	hfe3 **	Vce = 2.0 V, Ic = 0.7 A	135			_
Collector saturation voltage	VCE(sat) **	Ic = 5.0 A, Ic = 5 mA		0.27	0.4	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R1		_	_	-	Ω
E-to-B resistance	R2		7	10	13	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

AB1L2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = 30 \text{ V}, \text{ I}_{E} = 0$			100	nA
DC current gain	hfe1 **	Vce = 2.0 V, Ic = 0.1 A	150	400		-
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300	700		_
DC current gain	hfe3 **	Vce = 2.0 V, Ic = 0.7 A	135	600		-
Low level output voltage	Vol **	$V_{IN} = 5.0 \text{ V}, \text{ Ic} = 0.5 \text{ A}$		0.2	0.3	V
Low level input voltage	Vı∟ **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R1		329	470	611	Ω
E-to-B resistance	R2		3.29	4.7	6.11	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

AB1A3M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = 30 \text{ V}, \text{ I}_{E} = 0$			100	nA
DC current gain	hfe1 **	Vce = 2.0 V, Ic = 0.1 A	80			_
DC current gain	hfe2 **	Vce = 2.0 V, Ic = 0.5 A	100			-
DC current gain	hfe3 **	Vce = 2.0 V, Ic = 0.7 A	135			-
Low level output voltage	Vol **	V _{IN} = 5.0 V, Ic = 0.5 A		0.3	0.4	V
Low level input voltage	VIL **	Vce = 5.0 V, Ic = 100 µA			0.3	V
Input resistance	R1		0.7	1.0	1.3	kΩ
E-to-B resistance	R2		0.7	1.0	1.3	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

AB1F3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = 30 V, I_E = 0$			100	nA
DC current gain	hfe1 **	Vce = 2.0 V, Ic = 0.1 A	300			_
DC current gain	hfe2 **	Vce = 2.0 V, Ic = 0.5 A	300			_
DC current gain	hfe3 **	Vce = 2.0 V, Ic = 0.7 A	135			_
Low level output voltage	V OL **	$V_{IN} = 5.0 \text{ V}, \text{ Ic} = 0.3 \text{ A}$			0.3	V
Low level input voltage	Vı∟ **	Vcε = 5.0 V, Ic = 100 μA			0.3	V
Input resistance	Rı		1.54	2.2	2.86	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

AB1J3P

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = 30 V, I_E = 0$			100	nA
DC current gain	hfe1 **	Vce = 2.0 V, Ic = 0.1 A	300	600		-
DC current gain	hfe2 **	Vce = 2.0 V, Ic = 0.5 A	300	700		-
DC current gain	hfe3 **	Vce = 2.0 V, Ic = 0.7 A	135	600		_
Low level output voltage	V OL **	V _{IN} = 5.0 V, Ic = 0.2 A		0.14	0.3	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	Rı		2.31	3.3	4.29	kΩ
E-to-B resistance	R2		7	10	13	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

AB1L3N ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = 30 \text{ V}, \text{ I}_{E} = 0$			100	nA
DC current gain	hfe1 **	Vce = 2.0 V, Ic = 0.1 A	300			_
DC current gain	hfe2 **	Vce = 2.0 V, Ic = 0.5 A	300			-
DC current gain	hfe3 **	Vce = 2.0 V, Ic = 0.7 A	135			-
Low level output voltage	V OL **	V _{IN} = 5.0 V, Ic = 0.2 A			0.3	V
Low level input voltage	VIL **	Vce = 5.0 V, Ic = 100 µA			0.3	V
Input resistance	Rı		3.29	4.7	6.11	kΩ
E-to-B resistance	R2		7	10	13	kΩ

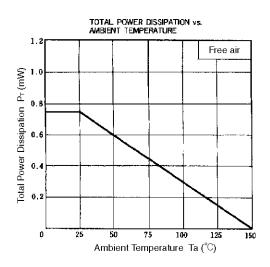
** PW \leq 350 μ s, duty cycle \leq 2 %

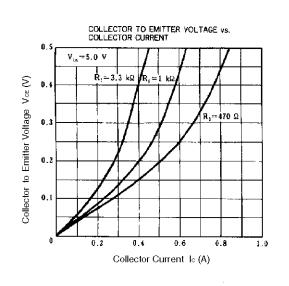
AB1A4M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

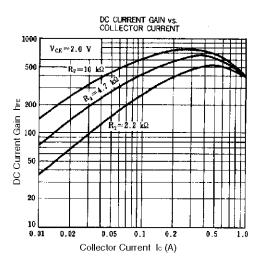
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 30 V, IE = 0			100	nA
DC current gain	hfe1 **	Vce = 2.0 V, Ic = 0.1 A	300			-
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300			_
DC current gain	hfe3 **	Vce = 2.0 V, Ic = 0.7 A	135			_
Low level output voltage	V OL **	V _{IN} = 5.0 V, Ic = 0.2 A			0.3	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R1		7	10	13	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

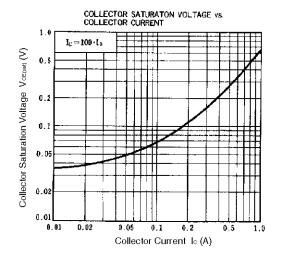
** PW \leq 350 μ s, duty cycle \leq 2 %

TYPICAL CHARACTERISTICS (Ta = 25°C)









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